ESD Protection Diode

Low Capacitance ESD Protection Diode for High Speed Data Line

The ESD8024 surge protection is designed specifically to protect Low Voltage Differential Signals (LVDS) for LCD panels. Ultra-low capacitance and low ESD clamping voltage make this device an ideal solution for protecting voltage sensitive data lines. The integrated 24 lines of protection offers a simplified solution with premier performance for LVDS applications.

Features

- Full Function LVDS Solution
- 4 pF Max, I/O to GND
- Protection for the Following IEC Standards: IEC 61000-4-2 (ESD) ±8 kV (Contact) IEC61000-4-5 (Lightning) 20 A (8/20 μs)
- UL Flammability Rating of 94 V-0
- This is a Pb-Free Device

Typical Applications

- LVDS
- LCD Panel TCON

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Operating Junction Temperature Range	T_J	-55 to +125	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C
Lead Solder Temperature – Maximum (10 Seconds)	TL	260	°C
IEC 61000-4-2 Contact (ESD) IEC 61000-4-2 Air (ESD)	ESD ESD	±30 ±30	kV kV
Maximum Peak Pulse Current 8/20 μs @ T _A = 25°C	I _{pp}	20	Α

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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CASE 485L



8024 ALYW=

8024 = Specific Device Code = Assembly Location Α

L = Wafer Lot = Year W = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping
ESD8024MNTAG	QFN24 (Pb-Free)	4000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

See Application Note AND8308/D for further description of survivability specs.

1

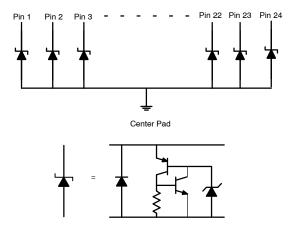
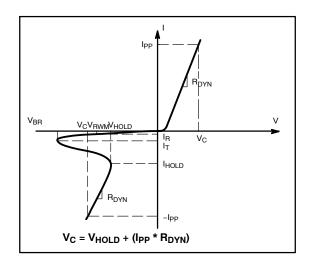


Figure 1. Pin Schematic

ELECTRICAL CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Symbol	Parameter
V_{RWM}	Working Peak Voltage
I _R	Maximum Reverse Leakage Current @ V _{RWM}
V_{BR}	Breakdown Voltage @ I _T
I _T	Test Current
V_{HOLD}	Holding Reverse Voltage
I _{HOLD}	Holding Reverse Current
R _{DYN}	Dynamic Resistance
I _{PP}	Maximum Peak Pulse Current
V _C	Clamping Voltage @ I _{PP} V _C = V _{HOLD} + (I _{PP} * R _{DYN})



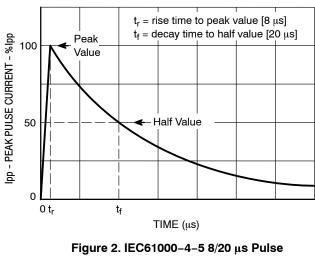
ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse Working Voltage	V_{RWM}	All Pins (1-24) to GND (Note 1)			2.5	V
Forward Voltage	V _F	I _F = 10 mA, GND to All Pins (1–24)	0.5	0.85	1.1	V
Breakdown Voltage	V_{BR}	I _T = 1 mA, All Pins (1–24) to GND	5.5	7.0	9.0	V
Reverse Leakage Current	I _R	V _{RWM} = 2.5 V, All Pins (1–24) to GND			0.5	μΑ
Holding Reverse Voltage	V _{HOLD}	I/O Pin to GND 1 1.5		1.5		V
Holding Reverse Current	I _{HOLD}	I/O Pin to GND		50		mA
Clamping Voltage	V _C	I _{PP} = 1 A, All Pins (1–24) to GND (8/20 μs pulse)			4.0	V
Clamping Voltage	V _C	I _{PP} = 10 A, All Pins (1–24) to GND (8/20 μs pulse)	ins (1-24) to GND (8/20 μs pulse)		7.0	V
Clamping Voltage	V _C	I _{PP} = 15 A, All Pins (1–24) to GND (8/20 μs pulse)			8.0	V
Clamping Voltage	V _C	IEC61000-4-2, ±8 kV Contact	See Figures 2 and 3		V	
Junction Capacitance	CJ	V _R = 0 V, f = 1 MHz between I/O Pins		2.0	pF	
Junction Capacitance	CJ	V _R = 0 V, f = 1 MHz between I/O Pins and GND	0 V, f = 1 MHz between I/O Pins and GND		4.0	pF

Surge protection devices are normally selected according to the working peak reverse voltage (V_{RWM}), which should be equal or greater than the DC or continuous peak operating voltage level.

Vpk (V)

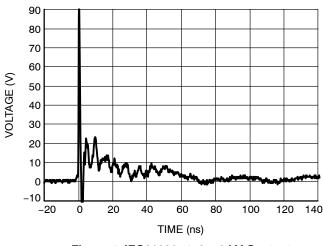
TYPICAL CHARACTERISTICS



20 18 16 14 12 10 8 GND-IO 6 IO-GND 2 0 10 15 20 25 30 lpk (A)

Figure 2. IEC61000-4-5 8/20 μs Pulse Waveform

Figure 3. Clamping Voltage vs. Peak Pulse Current (tp = 8/20 μs per Figure 2)



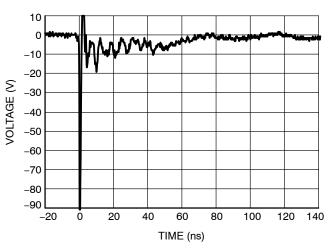
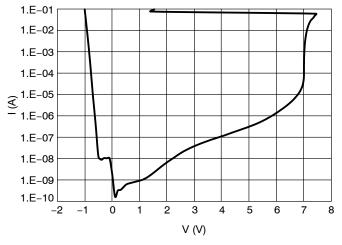


Figure 4. IEC61000-4-2 + 8 kV Contact Clamping Voltage

Figure 5. IEC61000-4-2 - 8 kV Contact Clamping Voltage



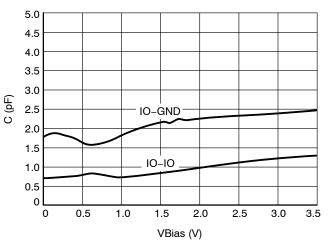


Figure 6. IV Characteristics

Figure 7. CV Characteristics

TYPICAL CHARACTERISTICS

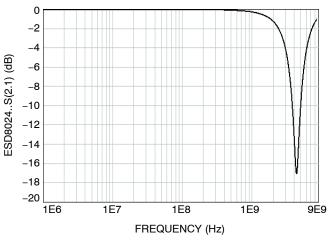


Figure 8. RF Insertion Loss

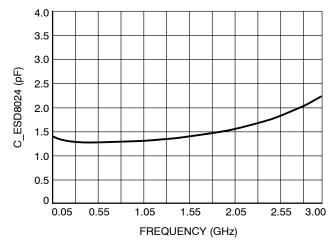


Figure 9. Capacitance over Frequency

PCB Layout Guidelines

Steps must be taken for proper placement and signal trace routing of the protection device in order to ensure the maximum survivability and signal integrity for the application. Such steps are listed below.

- Place the protection device as close as possible to the I/O connector to reduce the transient path to ground and improve the protection performance.
 - Consequently, place the device under protection as far as possible from the protection device to help further improve protection performance.
- Keep trace lengths connecting protection device pins to data lines as short as possible. These "stub" traces, if long enough, can create voltage drops that impede the turn-on of the protection device.
- Make sure to use differential design methodology and impedance matching of all high speed signal traces.
 - Use curved traces when possible to avoid unwanted reflections.
 - Keep the trace lengths equal between the positive and negative lines of the differential data lanes to avoid common mode noise generation and impedance mismatch.

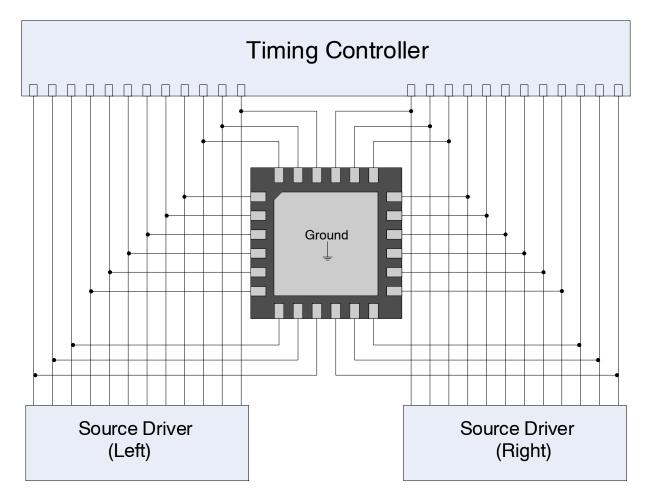


Figure 10. Board Routing Diagram - TCON LVDS Interface

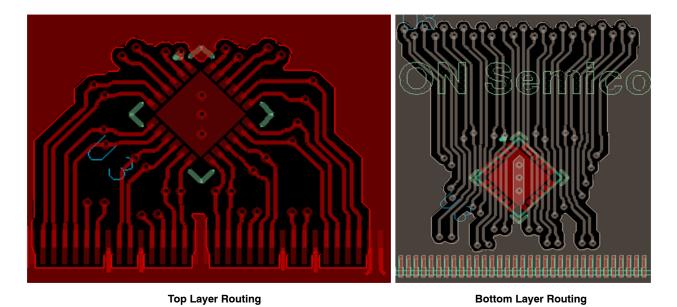
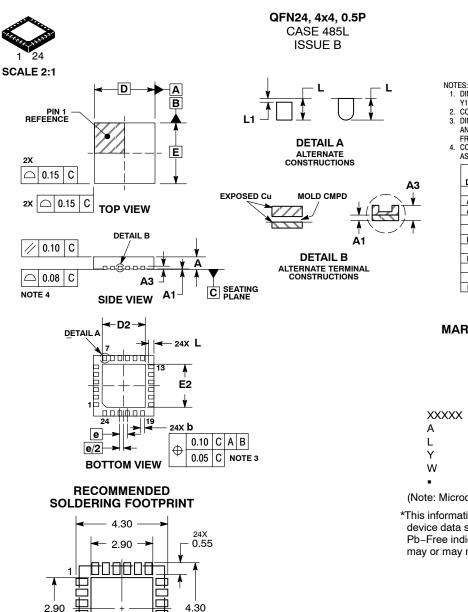


Figure 11. ESD8024 Recommended PCB Layout



24X

DIMENSIONS: MILLIMETERS

0.32

DATE 05 JUN 2012

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- T14-3M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM THE TERMINAL TIP.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN MAX		
Α	0.80	1.00	
A1	0.00	0.05	
A3	0.20 REF		
b	0.20	0.30	
D	4.00 BSC		
D2	2.70 2.90		
Е	4.00 BSC		
E2	2.70	2.90	
е	0.50 BSC		
L	0.30	0.50	
L1	0.05	0.15	

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code

= Assembly Location

= Wafer Lot

= Year = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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DESCRIPTION:	QFN24, 4X4, 0.5P		PAGE 1 OF 1

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P6KE8.2A SA110CA SA60CA SA64CA SMBJ12CATR SMBJ8.0A SMLJ30CA-TP ESD101-B1-02ELS E6327 ESD112-B1-02EL E6327
ESD119B1W01005E6327XTSA1 ESD5V0J4-TP ESD5V0L1B02VH6327XTSA1 ESD7451N2T5G 19180-510 CPDT-5V0USP-HF
3.0SMCJ33CA-F 3.0SMCJ36A-F HSPC16701B02TP D3V3Q1B2DLP3-7 D55V0M1B2WS-7 DESD5V0U1BL-7B DRTR5V0U4SL-7
SCM1293A-04SO ESD200-B1-CSP0201 E6327 ESD203-B1-02EL E6327 SM12-7 SMF8.0A-TP SMLJ45CA-TP CEN955 W/DATA
82350120560 82356240030 VESD12A1A-HD1-GS08 CPDUR5V0R-HF CPDUR24V-HF CPDQC5V0U-HF CPDQC5V0USP-HF
CPDQC5V0-HF D1213A-01LP4-7B D1213A-02WL-7 ESDLIN1524BJ-HQ 5KP100A